



20CTQ...SPbF 20CTQ...-1PbF

SCHOTTKY RECTIFIER

20 Amp

$I_{F(AV)} = 20\text{Amp}$
 $V_R = 35/ 45\text{V}$

Major Ratings and Characteristics


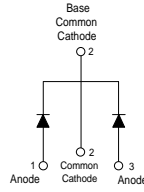

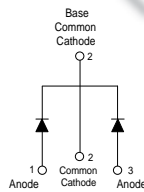
Characteristics	Values	Units
$I_{F(AV)}$ Rectangular waveform	20	A
V_{RRM} range	35/ 45	V
I_{FSM} @ tp = 5 μ s sine	1060	A
V_F @ 10 Apk, $T_J = 125^\circ\text{C}$ (per leg)	0.57	V
T_J range	-55 to 175	$^\circ\text{C}$

Description/ Features

The 20CTQ.. center tap Schottky rectifier series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175° C junction temperature. Typical applications are in switching power supplies, converters, free-wheeling diodes, and reverse battery protection.

- 175° C T_J operation
- Center tap TO-220 package
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Lead-Free ("PbF" suffix)

Case Styles

<p>20CTQ...SPbF</p>   <p>D²PAK</p>	<p>20CTQ...-1PbF</p>   <p>TO-262</p>
--	---

Voltage Ratings

Part number	20CTQ035SPbF 20CTQ035-1PbF	20CTQ040SPbF 20CTQ040-1PbF	20CTQ045SPbF 20CTQ045-1PbF
V_R Max. DC Reverse Voltage (V)	35	40	45
V_{RWM} Max. Working Peak Reverse Voltage (V)			

Absolute Maximum Ratings

Parameters	20CTQ	Units	Conditions
$I_{F(AV)}$ Max. Average Forward Current * See Fig. 5	20	A	50% duty cycle @ $T_C = 145^\circ\text{C}$, rectangular wave form
I_{FSM} Max. Peak One Cycle Non-Repetitive Surge Current (Per Leg) * See Fig. 7	1060	A	5 μs Sine or 3 μs Rect. pulse 10ms Sine or 6ms Rect. pulse
	265		
E_{AS} Non-Repetitive Avalanche Energy (Per Leg)	13	mJ	$T_J = 25^\circ\text{C}$, $I_{AS} = 2.0$ Amps, $L = 6.5$ mH
I_{AR} Repetitive Avalanche Current (Per Leg)	2.0	A	Current decaying linearly to zero in 1 μsec Frequency limited by T_J max. $V_A = 1.5 \times V_R$ typical

Electrical Specifications

Parameters	20CTQ	Units	Conditions
V_{FM} Max. Forward Voltage Drop (Per Leg) * See Fig. 1 (1)	0.64	V	@ 10A
	0.76	V	@ 20A
	0.57	V	@ 10A
	0.68	V	@ 20A
I_{RM} Max. Reverse Leakage Current (Per Leg) * See Fig. 2 (1)	2	mA	$T_J = 25^\circ\text{C}$
	15	mA	$T_J = 125^\circ\text{C}$
C_T Max. Junction Capacitance (Per Leg)	900	pF	$V_R = 5V_{DC}$ (test signal range 100Khz to 1Mhz) 25°C
L_S Typical Series Inductance (Per Leg)	8.0	nH	Measured lead to lead 5mm from package body
dv/dt Max. Voltage Rate of Change (Rated V_R)	10000	V/ μs	

(1) Pulse Width < 300 μs , Duty Cycle <2%

Thermal-Mechanical Specifications

Parameters	20CTQ	Units	Conditions
T_J Max. Junction Temperature Range	-55 to 175	$^\circ\text{C}$	
T_{stg} Max. Storage Temperature Range	-55 to 175	$^\circ\text{C}$	
R_{thJC} Max. Thermal Resistance Junction to Case (Per Leg)	3.25	$^\circ\text{C}/\text{W}$	DC operation * See Fig. 4
R_{thJC} Max. Thermal Resistance Junction to Case (Per Package)	1.63	$^\circ\text{C}/\text{W}$	DC operation
R_{thCS} Typical Thermal Resistance, Case to Heatsink	0.50	$^\circ\text{C}/\text{W}$	Mounting surface, smooth and greased
wt Approximate Weight	2(0.07)	g(oz.)	
T Mounting Torque	Min. 6(5)	Kg-cm (lbf-in)	
	Max. 12(10)		
Marking Device	20CTQ...S	Case style D ² Pak	
	20CTQ...-1	Case style TO-262	

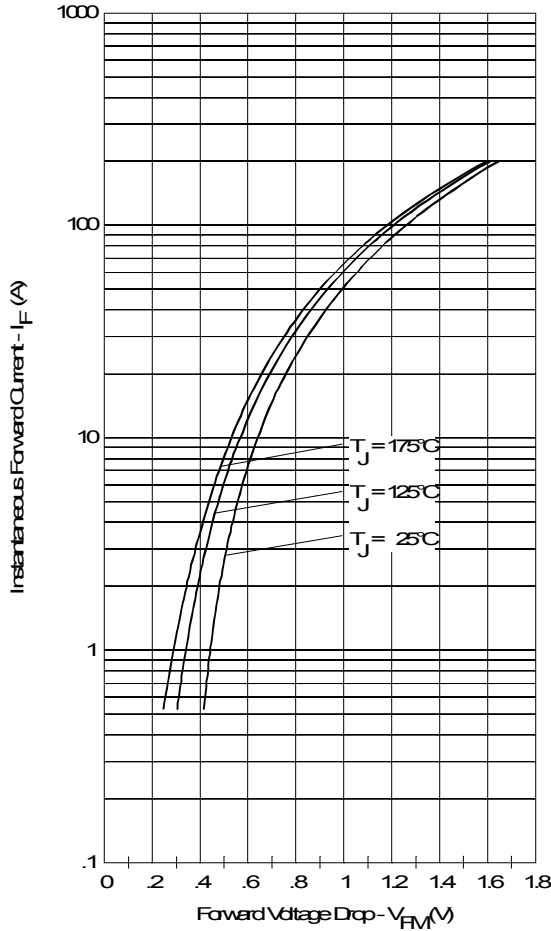


Fig. 1 - Max. Forward Voltage Drop Characteristics (Per Leg)

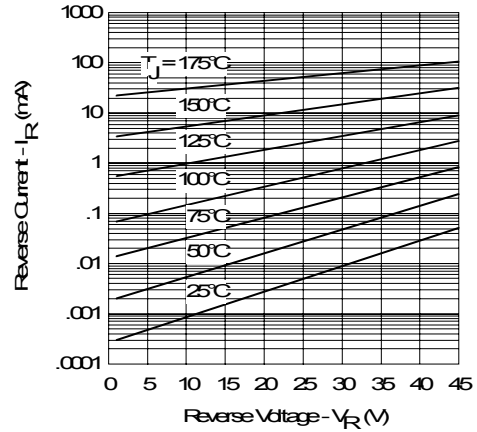


Fig. 2 - Typical Values Of Reverse Current Vs. Reverse Voltage (Per Leg)

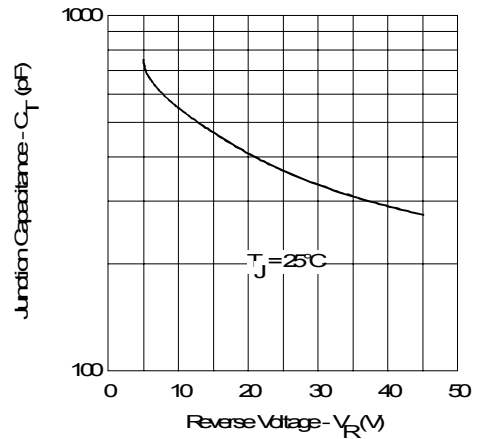


Fig. 3 - Typical Junction Capacitance Vs. Reverse Voltage (Per Leg)

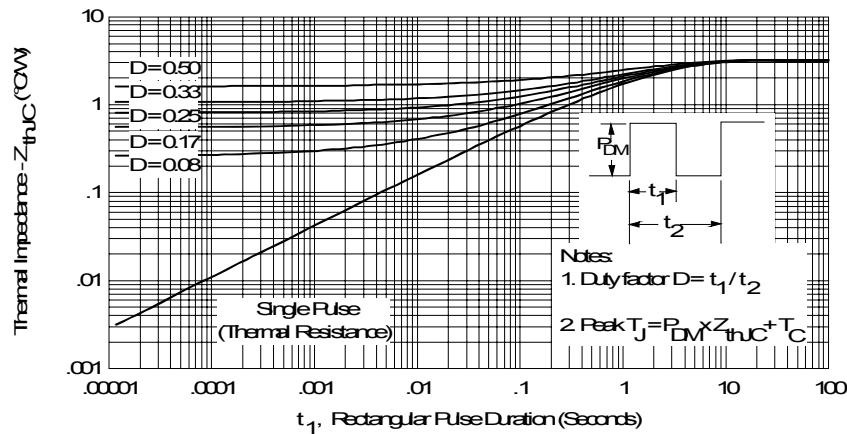


Fig. 4 - Max. Thermal Impedance Z_{thJC} Characteristics (Per Leg)

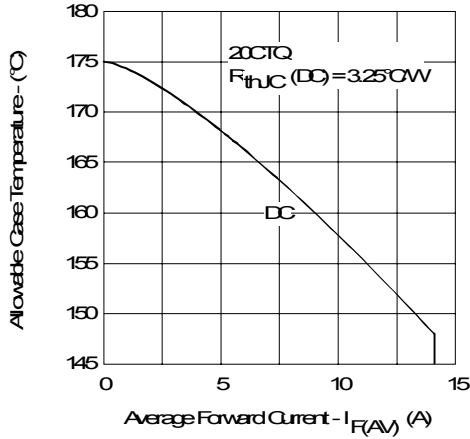


Fig. 5 - Max. Allowable Case Temperature Vs. Average Forward Current (Per Leg)

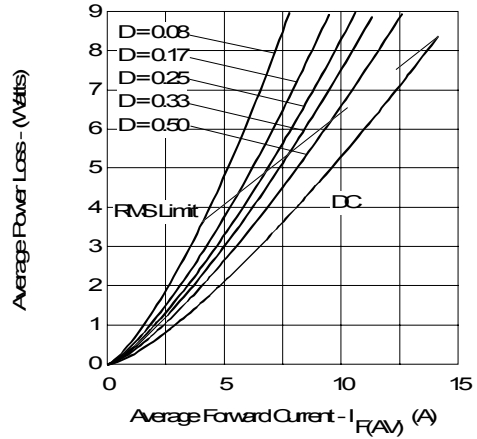


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

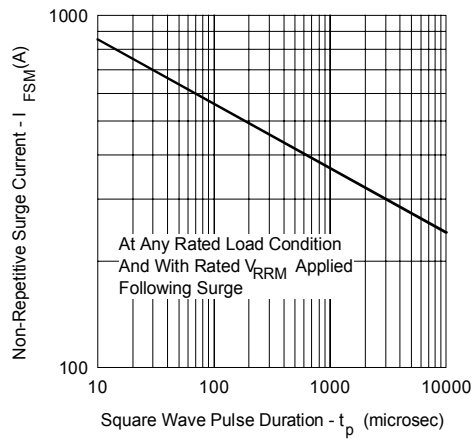


Fig. 7 - Max. Non-Repetitive Surge Current (Per Leg)

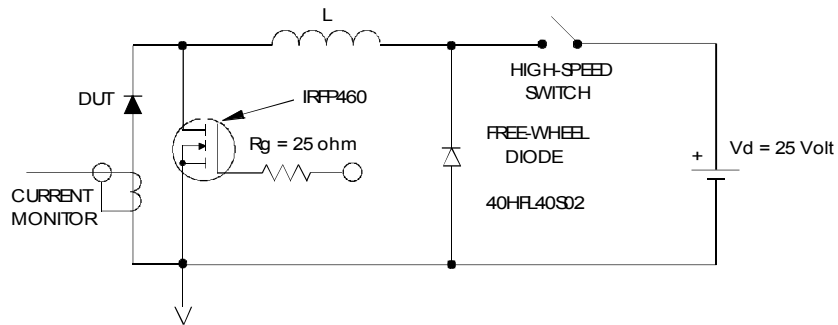


Fig. 8 - Unclamped Inductive Test Circuit

Outlines Table

NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
 3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [0.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
 4. DIMENSION b1 AND c1 APPLY TO BASE METAL ONLY.
 5. CONTROLLING DIMENSIONS: INCH.

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	.160	.190	4
A1	0.00	0.254	.000	.010	
b	0.51	0.99	.020	.039	
b1	0.51	0.89	.020	.035	
b2	1.14	1.78	.045	.070	4
c	0.38	0.74	.015	.029	
c1	0.38	0.58	.015	.023	4
c2	1.14	1.65	.045	.065	
D	8.51	9.65	.335	.380	3
D1	6.86	-	.270	-	
E	9.65	10.67	.380	.420	3
E1	6.22	-	.245	-	
e	2.54 BSC		.100 BSC		3
H	14.61	15.88	.575	.625	
L	1.78	2.79	.070	.110	
L1	-	1.65	-	.065	
L2	1.27	1.78	.050	.070	3
L3	0.25 BSC		.010 BSC		
L4	4.78	5.28	.188	.208	3
m	17.78	-	.700	-	
m1	8.89	-	.350	-	
n	11.43	-	.450	-	
o	2.08	-	.082	-	
p	3.81	-	.150	-	
R	0.51	0.71	.020	.028	3
θ	90°	93°	90°	93°	

LEAD ASSIGNMENTS
 HEXFEET
 1.- GATE
 2, 4.- DRAIN
 3.- SOURCE
 IGBTs, CoPACK
 1.- GATE
 2, 4.- COLLECTOR
 3.- EMITTER
 DIODES
 1.- ANODE *
 2, 4.- CATHODE
 3.- ANODE
 * PART DEPENDENT.

Conform to JEDEC outline D²Pak (SMD-220)
 Dimensions in millimeters and (inches)

NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
 3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [0.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
 4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.
 5. DIMENSION b1 AND c1 APPLY TO BASE METAL ONLY.
 6. CONTROLLING DIMENSION: INCH.
 7.- OUTLINE CONFORM TO JEDEC TO-262 EXCEPT A1(max.), b(min.) AND D1(min.) WHERE DIMENSIONS DERIVED THE ACTUAL PACKAGE OUTLINE.

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	.160	.190	5
A1	2.03	3.02	.080	.119	
b	0.51	0.99	.020	.039	
b1	0.51	0.89	.020	.035	
b2	1.14	1.78	.045	.070	5
b3	1.14	1.73	.045	.068	
c	0.38	0.74	.015	.029	5
c1	0.38	0.58	.015	.023	
c2	1.14	1.65	.045	.065	5
D	8.58	9.65	.330	.380	
D1	6.86	-	.270	-	4
E	9.65	10.67	.380	.420	
E1	6.22	-	.245	-	4
e	2.54 BSC		.100 BSC		
L	13.46	14.10	.530	.555	4
L1	-	1.65	-	.065	
L2	3.56	3.71	.140	.146	

LEAD ASSIGNMENTS
 HEXFEET
 1.- GATE
 2.- DRAIN
 3.- SOURCE
 4.- DRAIN
 IGBTs, CoPACK
 1.- GATE
 2.- COLLECTOR
 3.- EMITTER
 4.- COLLECTOR

Modified JEDEC outline TO-262
 Dimensions in millimeters and (inches)

Part Marking Information

D²PAK

EXAMPLE: THIS IS A 20CTQ045S
 LOT CODE 8024
 ASSEMBLED ON WW 02, 2000

Note: "P" in assembly line position indicates "Lead-Free"

EXAMPLE: THIS IS A 20CTQ045-1
 LOT CODE 1789
 ASSEMBLED ON WW 19, 2002

Note: "P" in assembly line position indicates "Lead-Free"

Tape & Reel Information

SECTION Y-Y

Ao	10.50 +/- 0.1
B0	15.80 +/- 0.1
B2	10.25 +/- 0.1
K0	4.90 +/- 0.1
F	11.50 +/- 0.1
P1	16.00 +/- 0.1
W	24.00 +/- 0.3

NOTES:

- 1.0 10 SPROCKET HOLE PITH CUMULATIVE TOLERANCE ±.02
- 2.0 CAMBER NOT TO EXCEED 1mm In 100mm
- 3.0 MATERIAL: CONDUCTIVE BLACK STYRENIC ALLOY
- 4.0 K0 MEASURED FROM A PLANE ON THE INSIDE BOTTOM OF THE POCKET TO THE TOP SURFACE OF THE CARRIER
- 5.0 MEASURED FROM CENTRELINE OF SPROCKET HOLE TO CENTRELINE OF POCKET
- 6.0 VENDOR: (OPTIONAL)
- 7.0 MUST ALSO MEET REQUIREMENTS OF EIA STANDAR #EIA-481A TAPING OF SURFACE MOUNT COMPONENTS FOR AUTOMATIC PLACEMENT
- 8.0 SURFACE RESISTIVITY OF MOLDED MATL. MUST MEASURE LESS OR EQUAL TO 10⁶ OHMS PER SQUARE. MEASURED IN ACCORDANCE TO PROCEDURE GIVEN IN ASTM D-257 & ASTM D-991
- 9.0 TOTAL LENGTH PER REEL MUST BE 45 METERS
- 10.0 © CRITICAL

Dimensions in millimeters and (inches)

Ordering Information Table

Device Code							
1	2	3	4	5	6	7	8
20	C	T	Q	045	S	TRL	PbF
1	-	Current Rating (20A)					
2	-	Circuit Configuration					
		C = Common Cathode					
3	-	T = TO-220					
4	-	Schottky "Q" Series					
5	-	Voltage Ratings					
6	-	• S = D ² Pak					
		• -1= TO-262					
7	-	• none = Tube (50 pieces)					
		• TRL = Tape & Reel (Left Oriented - for D ² Pak only)					
		• TRR = Tape & Reel (Right Oriented - for D ² Pak only)					
8	-	• none = Standard Production					
		• PbF = Lead-Free					

Data and specifications subject to change without notice.
 This product has been designed and qualified for Industrial Level and Lead-Free.
 Qualification Standards can be found on IR's Web site.



Notice

The products described herein were acquired by Vishay Intertechnology, Inc., as part of its acquisition of International Rectifier's Power Control Systems (PCS) business, which closed in April 2007. Specifications of the products displayed herein are pending review by Vishay and are subject to the terms and conditions shown below.

Specifications of the products displayed herein are subject to change without notice. Vishay Intertechnology, Inc., or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Vishay's terms and conditions of sale for such products, Vishay assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of Vishay products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Vishay for any damages resulting from such improper use or sale.

International Rectifier®, IR®, the IR logo, HEXFET®, HEXSense®, HEXDIP®, DOL®, INTERO®, and POWIRTRAIN® are registered trademarks of International Rectifier Corporation in the U.S. and other countries. All other product names noted herein may be trademarks of their respective owners.